

**Annex B.ii. Photograph 2: EUT Internal Photo**



Cover Off - Top View



Cover Off - Rear Housing View



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Title: EMC Test Report for Mobile Phone  
Main Model: S470  
Serial Model: N/A  
To: FCC Part 15 Subpart B Class B: 2012, ANSI C63.4:2009

Report No.: 13070170-FCC-E  
Issue Date: July 26, 2013  
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Adapter View



Battery View





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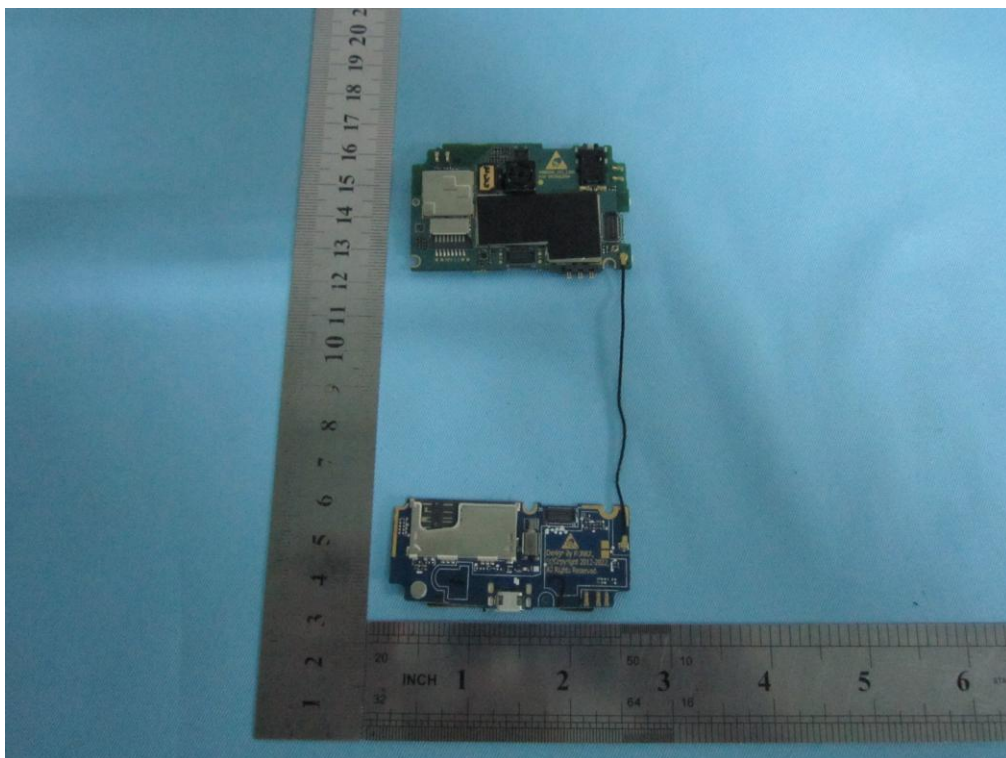
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Rear Housing - Uncover View



Mainboard - Bottom View

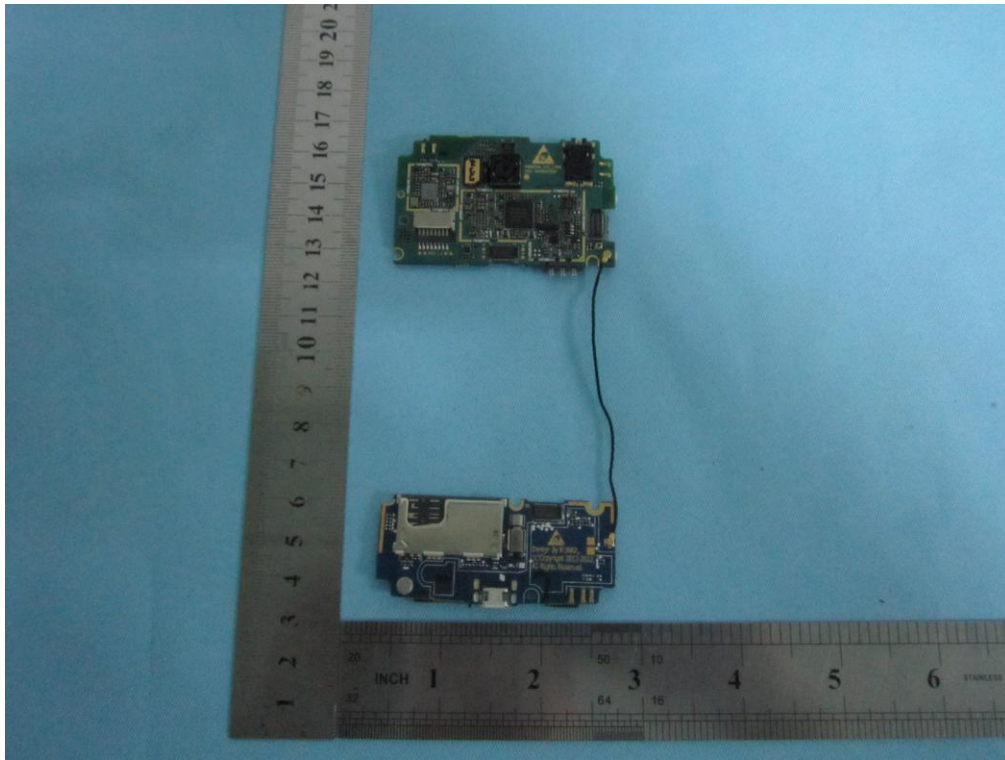


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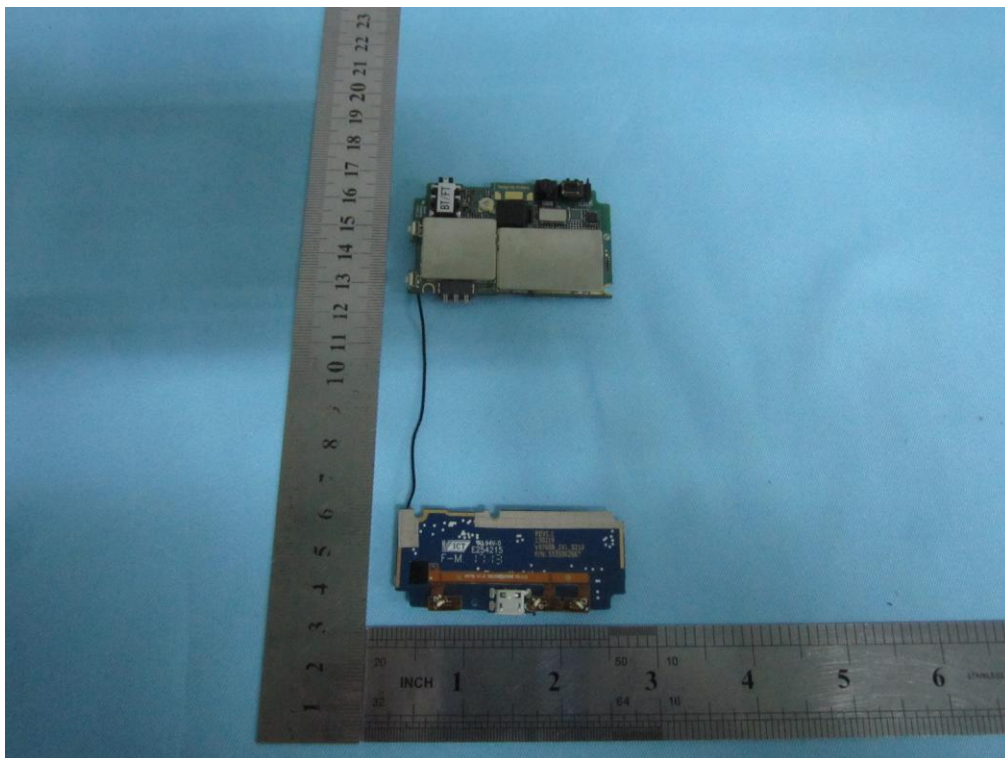
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Mainboard Without Shielding - Bottom View



Mainboard - Top View



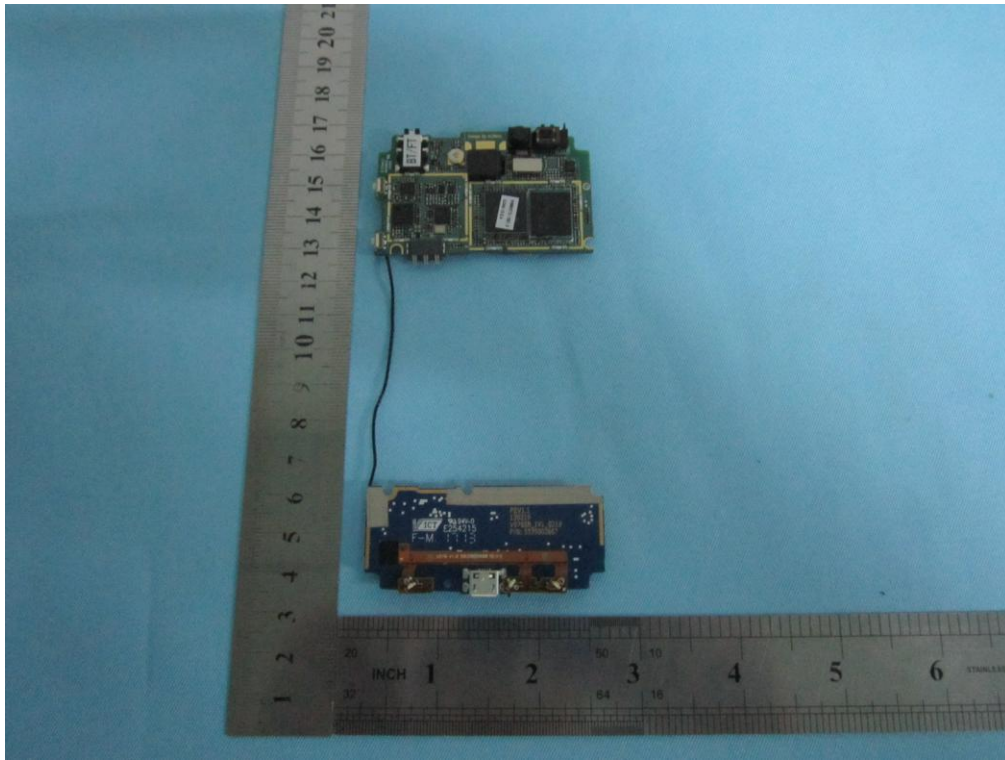


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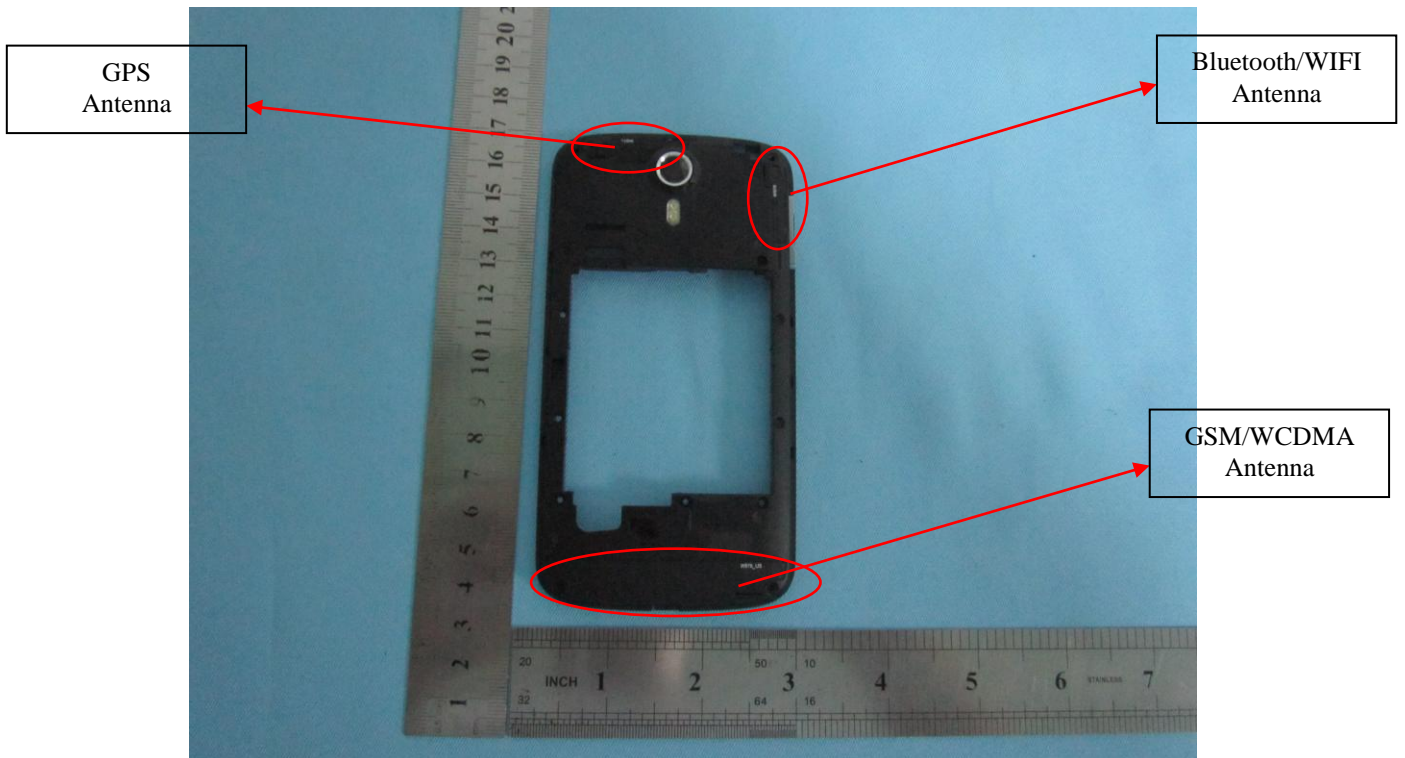
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Mainboard Without Shielding - Top View



Antenna View